/ Descriptions

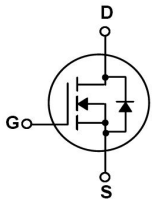
/ Features

DS dv/dt

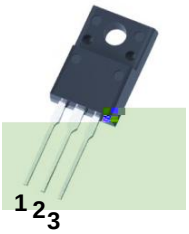
/ Applications

DC/DC

/ Equivalent Circuit

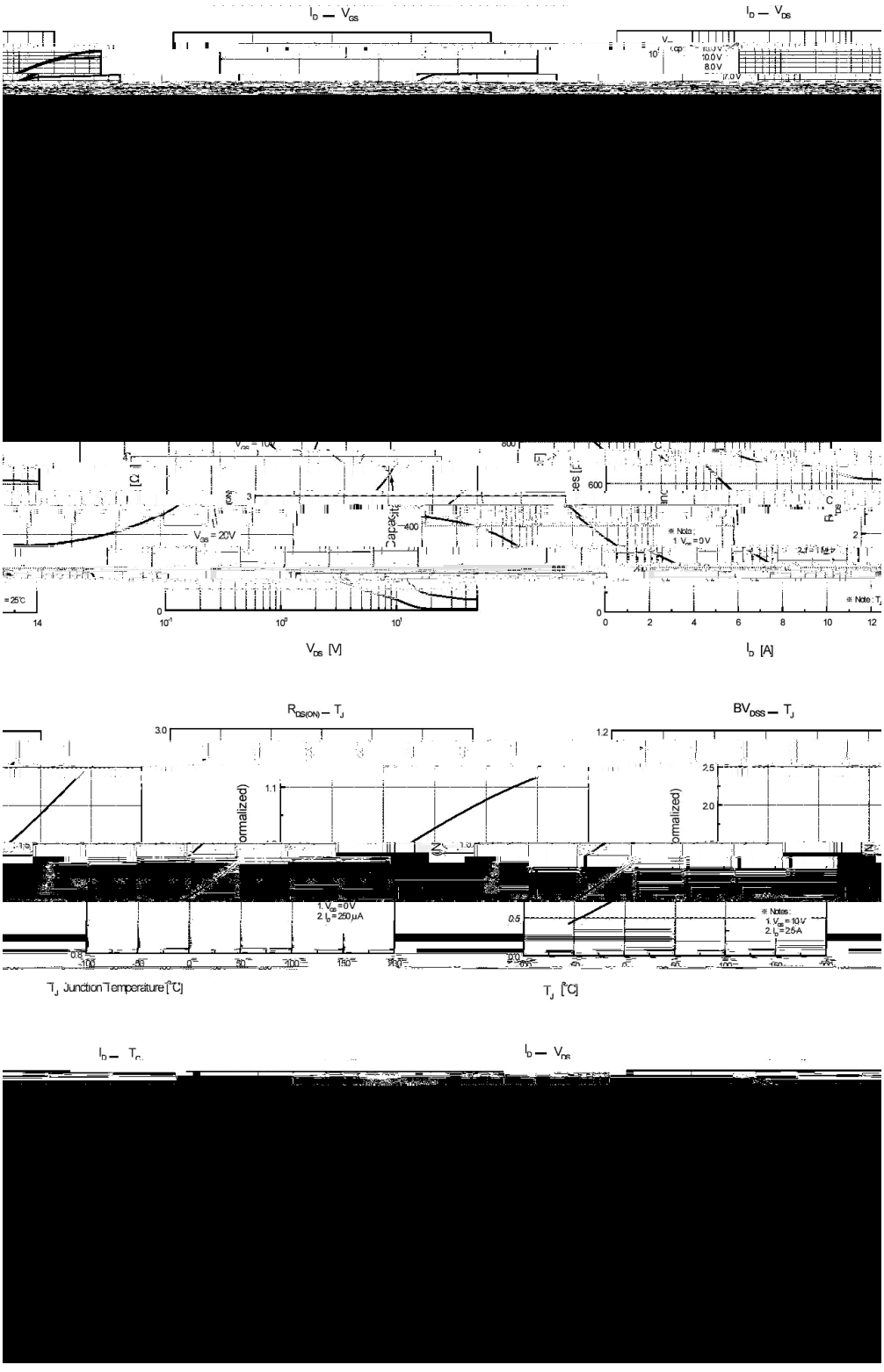


/ Pinning

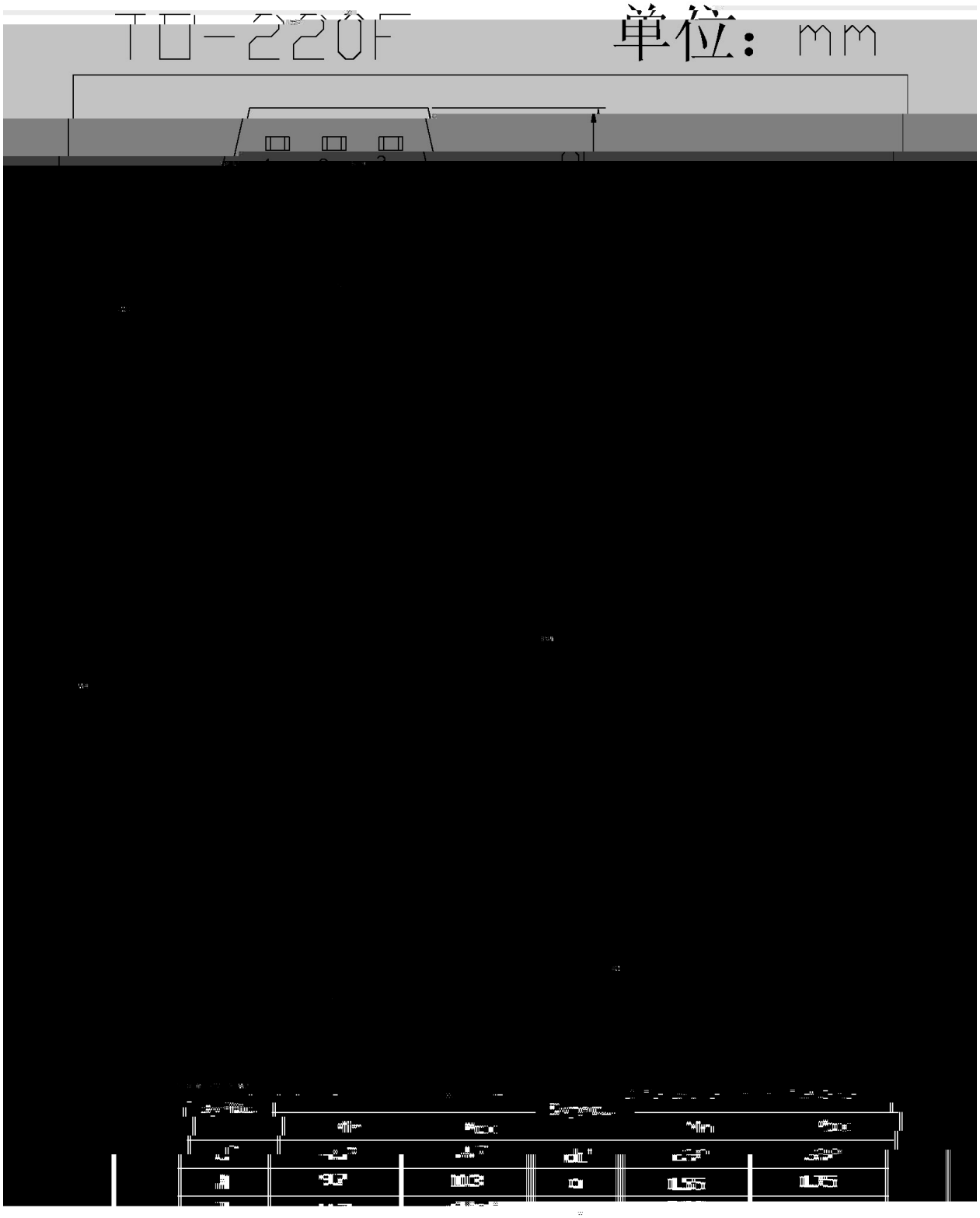


/ h_{FE} Classifications & Marking

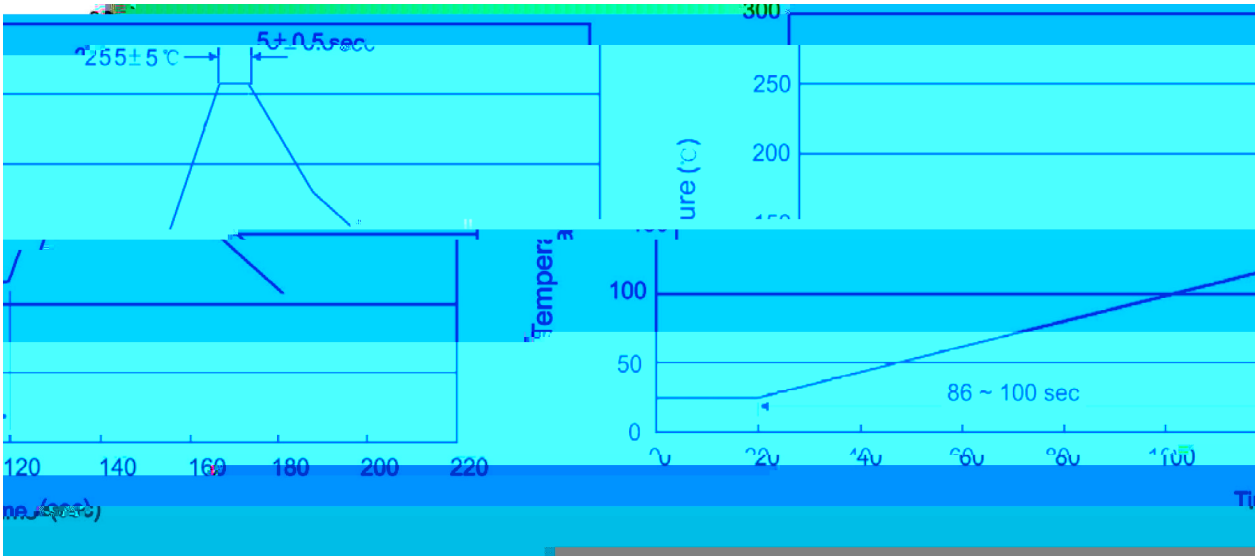
/ Electrical Characteristic Curve



/ Package Dimensions



( ) / Temperature Profile for Dip Soldering(Pb-Free)



± ± ± ±

/ Resistance to Soldering Heat Test Conditions

± ±

/ Packaging SPEC.

	包装数量			包装尺寸 :
封装形式	Units/Bag 只/袋	Bags/Inner Box 袋/盒	Units/Inner Box 只/盒	